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CONFIRMATION NO. 1220

<b>SERIAL NUMBER</b> 10/826,752	<b>FILING OR 371(c) DATE</b> 04/16/2004 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2813	<b>ATTORNEY DOCKET NO.</b> APS01-002B
<b>APPLICANTS</b> Romeo Emmanuel P. Alvarez, Singapore, SINGAPORE;				
<b>** CONTINUING DATA *****</b> This application is a DIV of 10/315,534 12/10/2002 PAT 6,732,913 and is a CIP of 09/843,248 04/26/2001 PAT 6,592,019				
<b>** FOREIGN APPLICATIONS *****</b> SINGAPORE 200107810-4 12/10/2001				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED** SMALL ENTITY **</b> ** 06/25/2004				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after met Verified and Acknowledged <i>[Signature]</i> Allowance Examiner's Signature <i>[Signature]</i> Initials <i>[Signature]</i>		<b>STATE OR COUNTRY</b> SINGAPORE	<b>SHEETS DRAWING</b> 12	<b>TOTAL CLAIMS</b> 18
				<b>INDEPENDENT CLAIMS</b> 2
<b>ADDRESS</b> George O. Saile 28 Davis Avenue Poughkeepsie, NY12603				
<b>TITLE</b> Method for forming a wafer level chip scale package, and package formed thereby				
<b>FILING FEE RECEIVED</b> 385	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	